



YOUSHANG SEMICONDUCTOR

设计研发新型功率器件

各类小信号开关

中低压及高压大电流等场效应管

0755-83047638

ysbdt@szyoushang.cn

www.szyoushang.cn



企业微信二维码



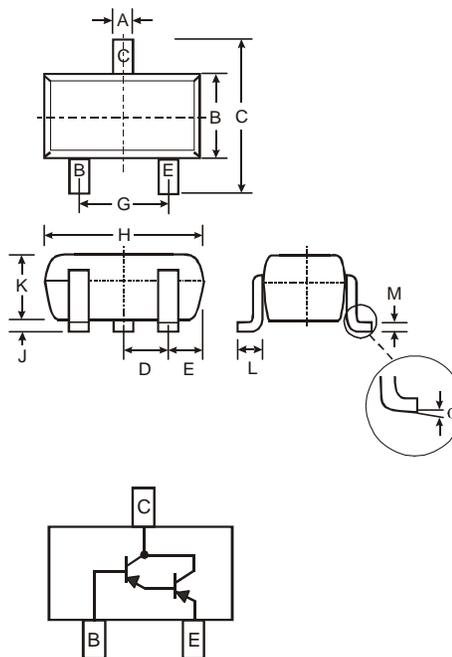
企业QQ二维码

Features

- Epitaxial Planar Die Construction
- Complementary NPN Types Available (NK-MMSTA13/NK-MMSTA14)
- Ultra-Small Surface Mount Package
- Ideal for Medium Power Amplification and Switching
- High Current Gain

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- NK-MMSTA63 Marking K2E, K3E, See Page 3
- NK-MMSTA64 Marking K3E, See Page 3
- Ordering & Date Code Information: See Page 3
- Weight: 0.006 grams (approximate)



SOT-323		
Dim	Min	Max
A	0.25	0.40
B	1.15	1.35
C	2.00	2.20
D	0.65 Nominal	
E	0.30	0.40
G	1.20	1.40
H	1.80	2.20
J	0.0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.18
α	0°	8°
All Dimensions in mm		

Maximum Ratings @_{T_A} = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CB0}	-30	V
Collector-Emitter Voltage	V _{CE0}	-30	V
Emitter-Base Voltage	V _{EBO}	-10	V
Collector Current - Continuous	I _C	-500	mA
Power Dissipation (Note 1)	P _d	200	mW
Thermal Resistance, Junction to Ambient (Note 1)	R _{θJA}	625	°C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-55 to +150	°C

@ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)					
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	-30	—	V	$I_C = -100\mu\text{A}$, $V_{BE} = 0\text{V}$
Collector Cutoff Current	I_{CBO}	—	-100	nA	$V_{CB} = -30\text{V}$, $I_E = 0$
Emitter Cutoff Current	I_{EBO}	—	-100	nA	$V_{EB} = -10\text{V}$, $I_C = 0$
ON CHARACTERISTICS (Note 5)					
DC Current Gain	NK-MMSTA63 NK-MMSTA64 NK-MMSTA63 NK-MMSTA64	h_{FE}	5,000 10,000 10,000 20,000	—	$I_C = -10\text{mA}$, $V_{CE} = -5.0\text{V}$ $I_C = -10\text{mA}$, $V_{CE} = -5.0\text{V}$ $I_C = -100\text{mA}$, $V_{CE} = -5.0\text{V}$ $I_C = -100\text{mA}$, $V_{CE} = -5.0\text{V}$
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	—	-1.5	V	$I_C = -100\text{mA}$, $I_B = -100\mu\text{A}$
Base- Emitter Saturation Voltage	$V_{BE(SAT)}$	—	-2.0	V	$I_C = -100\text{mA}$, $V_{CE} = -5.0\text{V}$
SMALL SIGNAL CHARACTERISTICS					
Current Gain-Bandwidth Product	f_T	125	—	MHz	$V_{CE} = -5.0\text{V}$, $I_C = -10\text{mA}$, $f = 100\text{MHz}$

Notes: 5. Short duration pulse test used to minimize self-heating effect.

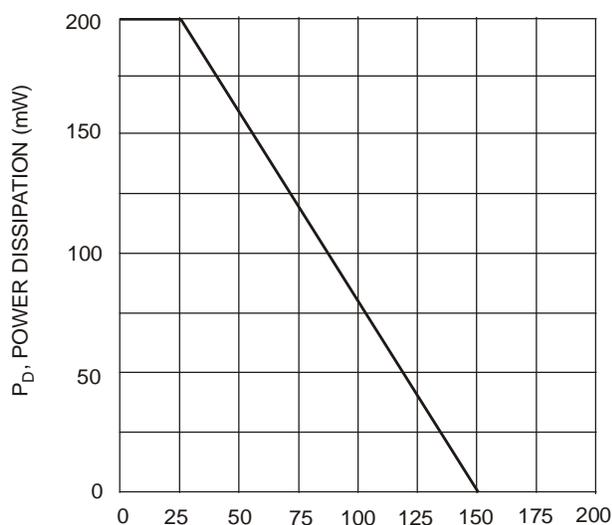

 T_A , AMBIENT TEMPERATURE ($^\circ\text{C}$)

Fig. 1, Max Power Dissipation vs. Ambient Temperature

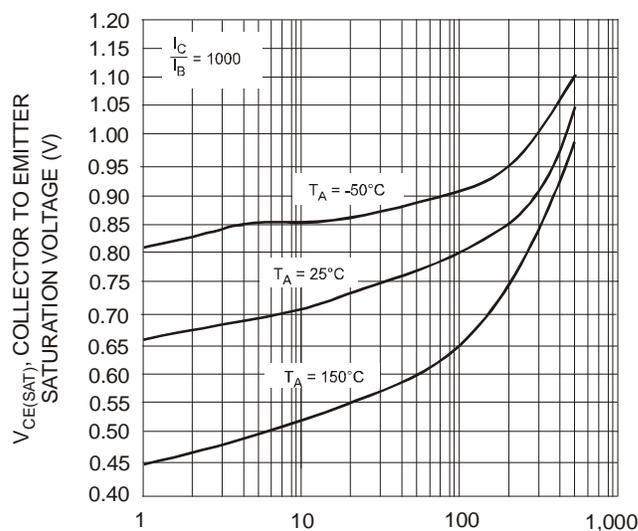

 I_C , COLLECTOR CURRENT (mA)

Fig. 2, Collector Emitter Saturation Voltage vs. Collector Current

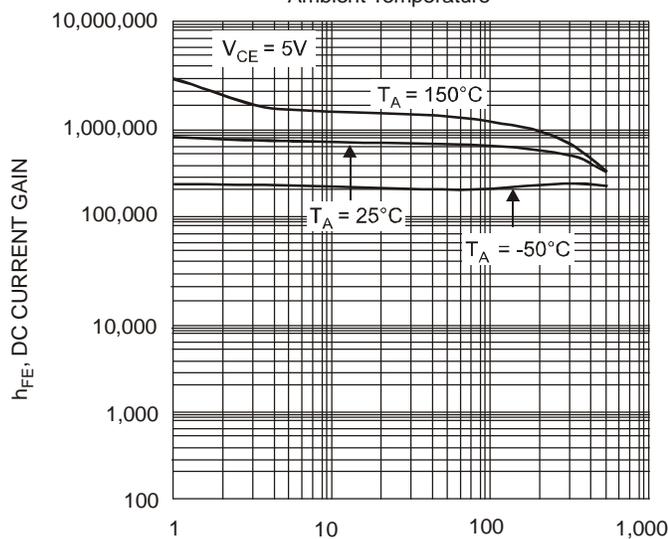

 I_C , COLLECTOR CURRENT (mA)

Fig. 3, DC Current Gain vs. Collector Current

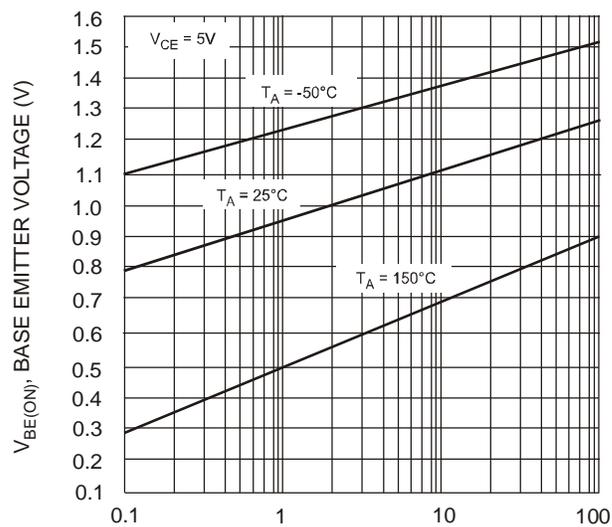

 I_C , COLLECTOR CURRENT (mA)

Fig. 4, Base Emitter Voltage vs. Collector Current

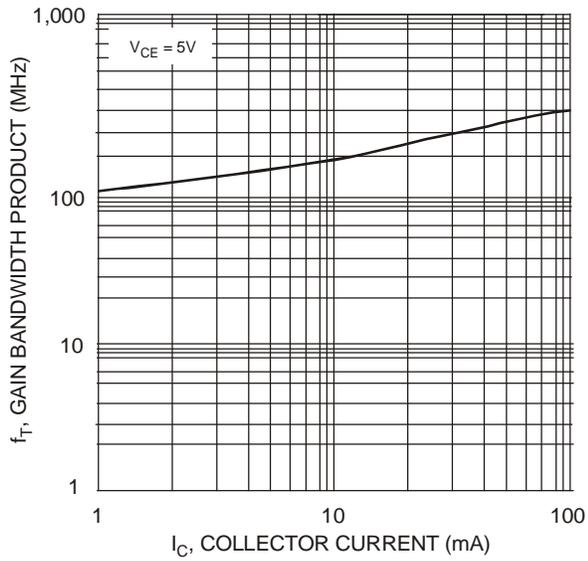


Fig. 5, Gain Bandwidth Product vs. Collector Current